



SMT current sense transformers

EP10 Series

Series/Type: **B78419**

Date: September 2024

Construction

- Ferrite core
- Primary winding: frame molded in
- Secondary winding: copper wire
- Creepage distance $N_p/(N_s, \text{core})$ 6 mm
- Clearance distance N_p/N_s (CuL) 3.5 mm
- Clearance distance N_p/core 5.3 m
- Plastic bobbin (UL94-V0, CTI ≥ 175)



Features

- Very low DC resistance
- Different turn ratios
- Small SMD package
- RoHS compatible
- Qualified to AEC-Q200E
- Design complies with IEC 61558-2-16
(Basic insulation, working voltage RMS 500 V)
- Insulation distances in compliance with IEC 60664
(Basic insulation, working voltage RMS 500 V)
- UL 1446 Class 155 (F) electrical insulation system 

Applications

- Switch-mode power supplies
- Feedback control
- Overload sensing
- Load drop/shut down detection

Terminals

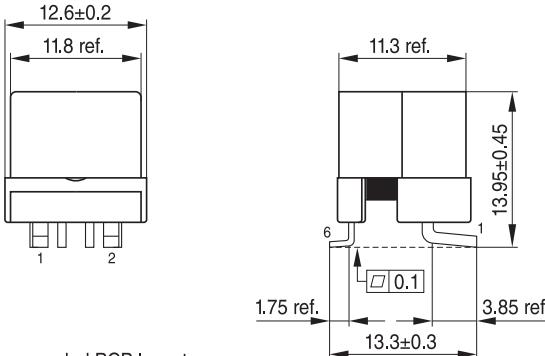
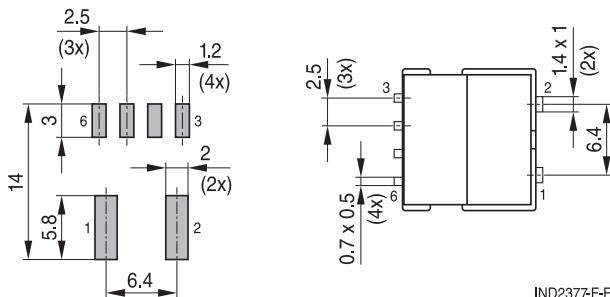
- L-Pins

Marking

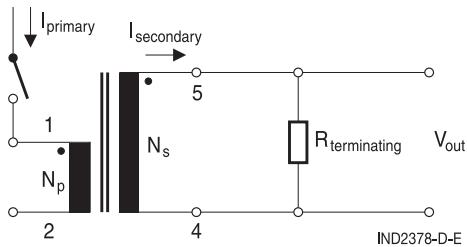
- Product brand, middle block of ordering code, date code, pin 1 marker, production place identification code
Minimum data on packaging:
Manufacturer's logo, ordering code, quantity, date code

Delivery mode and packing units

- Blister tape
- Packing unit: 200 pcs.

Dimensional drawingRecommended PCB layout
(Top view)

IND2377-F-E

Application circuit and pinning

Technical data and measuring conditions

All data is specified at +25 °C if not mentioned otherwise. All values without tolerance are typical values.

Typical frequency range	50 ... 250 kHz
High voltage	2400 V AC, 50 Hz, 1 s (winding to winding) Type test 60 s
Inductance L (5-4)	Measured at 20 kHz, 10 mV, +25 °C
DC resistance R_{max} (1-2)	Measured at +25 °C
DC resistance R_{max} (5-4)	Measured at +25 °C
Sensed current: $I_{p,RMS}$	The max. input current of 30 A causes approx. +40 °C temperature rise
Couple capacitance C_p (1-5)	Measured at 10 kHz, 1 V, +25 °C
Resistance to soldering heat	Reflow profile to JEDEC J-STD 020F, 3 cycles, Peak temperature +245 °C, measured on pin (to IEC 60068-2-58, test Td_2 , method 2)
Operating temperature range	-40 °C ... +150 °C (component)
Pollution degree	P2 (to IEC 61558-1, 60664)
Insulation thermal class	+155 °C (F) (to IEC 60085)
Weight	Approx. 4.5 g
Approvals	UL 1446 class 155 (F) (E320370)

$$B_{max} = \frac{V_{out, max} \cdot \delta_{max}}{N_s \cdot A_e \cdot f_{osc}}$$

With:

B_{max}	Maximum magnetic flux density in the ferrite core of the current sense transformer
$V_{out, max}$	Maximum output voltage of the measurement signal
δ_{max}	Maximum duty cycle
N_s	Number of turns of the secondary winding of the current sense transformer
A_e	Effective magnetic area of the ferrite core
f_{osc}	Operating frequency of the switching operator IC
Typical value for A_e :	$10.7 \times 10^{-6} \text{ m}^2$
Typical B_{max} :	< 220 mT

$$R_T = \frac{V_{out, max} \cdot N_s}{I_{IN, max}}$$

With:

R_T	Resistance of burden resistor
$V_{out, max}$	Maximum output voltage of the measurement signal
N_s	Number of turns of the secondary side of the CST
$I_{IN, max}$	Maximum input current (peak current)

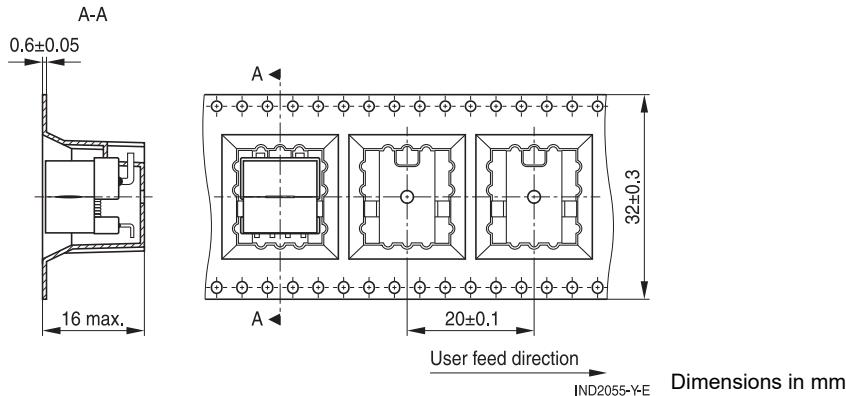
Characteristics and ordering codes

L_{min} (5-4) mH	Turns ratio $N_p : N_s$	Voltage time product +120 °C ¹) mA	C_p pF	R_{max} (1-2) mΩ	R_{max} (4-5) Ω	Recommended R_T ²)	Ordering code
1.7	1:50	117	4	0.5	1.5	1.6	B78419A2288A003
3.0	1:70	164	4	0.5	2.1	2.3	B78419A2289A003
7.0	1:100	235	4	0.5	3.1	3.3	B78419A2251A003
11.0	1:125	294	4	0.5	4.0	4.1	B78419A2290A003
25.0	1:180	423	4	0.5	7.4	6.0	B78419A2271A003

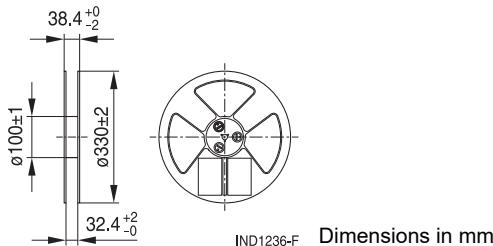
- 1) The maximum volt-sec rating limits the peak flux density to 220 mT when used in a unipolar drive application. For bipolar drive applications, a maximum volt-sec of two times is acceptable.
- 2) Burden Resistor value is calculated by taking V_{out} as 1 V reference and with maximum input current flowing through the input (30 A).

Taping and packing

Blister tape



Reel



Cautions and warnings

- Please note the recommendations in our Inductors data book (latest edition), online catalogs and in the data sheets.
 - Particular attention should be paid to the derating curves, if given. Derating applies in the case the ambient temperature in application exceeds the rated temperature of the component.
 - Ensure the operation temperature of the component in application not to exceed the maximum specified value or the upper climatic category temperature.
 - The soldering conditions should also be observed. Temperatures quoted in relation to wave soldering refer to the pins only. Temperatures specified in relation to reflow soldering can also refer to the pins or terminals for products with larger thermal mass, as in such cases, the temperature difference to the top of the component is too big (e.g., high proportion of core within the component).
- If the components are to be washed varnished it is necessary to check whether the washing varnish agent that is used has a negative effect on the wire insulation, any plastics that are used, or on glued joints. It is possible for washing varnish agent residues to have a negative effect in the long-term on wire insulation.
Washing processes may damage the product due to the possible static or cyclic mechanical loads (e.g., ultrasonic cleaning). They may cause cracks to develop on the product and its parts, which might lead to reduced reliability or lifetime.
- The following points must be observed if the components are potted, sealed, or varnished in customer applications:
 - Many potting, sealing, or varnishing materials shrink as they harden. They therefore exert a pressure on the plastic housing or core. This pressure can have a deleterious effect on electrical properties, and in extreme cases can damage the core or plastic housing mechanically.
 - It is necessary to check whether the potting, sealing or varnishing materials used attack or destroy the wire insulation, plastics, or glue.
 - The effect of the potting, sealing, or varnishing materials may change the high-frequency behavior of the components.
- Magnetic core materials such as ferrites are sensitive to direct impact. This can cause the core material to flake or lead to breakage of the magnetic core material.
- Any type of tension or pressure on the product may result in damage and affect its functionality and reliability.
 - The products are only to be attached to fixings or mounting holes provided for this purpose in accordance with the data sheet.
 - If additional mechanical forces are applied to the component, e.g., application of gap pads, it is necessary to check whether they attack or destroy any part of the component.
 - It is not permitted for the product specified in the data sheet to assume a mechanical function in the final application.
- Inductance value can drop if external metallic or magnetic parts will be put close to the coil or into the air gap of the coil or core or magnetic material.
- Even for customer-specific products, conclusive validation of the component in the circuit can only be carried out by the customer.

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The ordering code for one and the same product can be represented differently in data sheets, data books, other publications, on the company website, or in order-related documents such as shipping notes, order confirmations and product labels. **The varying representations of the ordering codes are due to different processes employed and do not affect the specifications of the respective products.** Detailed information can be found on the Internet under www.tdk-electronics.tdk.com/orderingcodes.

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1. Some parts of this publication contain **statements about the suitability of our products for certain areas of application**. These statements are based on our knowledge of typical requirements that are often placed on our products in the areas of application concerned. We nevertheless expressly point out that **such statements cannot be regarded as binding statements about the suitability of our products for a particular customer application**. As a rule we are either unfamiliar with individual customer applications or less familiar with them than the customers themselves. For these reasons, it is always ultimately incumbent on the customer to check and decide whether a product with the properties described in the product specification is suitable for use in a particular customer application.
2. We also point out that **in individual cases, a malfunction of electronic components or failure before the end of their usual service life cannot be completely ruled out in the current state of the art, even if they are operated as specified**. In customer applications requiring a very high level of operational safety and especially in customer applications in which the malfunction or failure of an electronic component could endanger human life or health (e.g. in accident prevention or life-saving systems), it must therefore be ensured by means of suitable design of the customer application or other action taken by the customer (e.g. installation of protective circuitry or redundancy) that no injury or damage is sustained by third parties in the event of malfunction or failure of an electronic component.
3. **The warnings, cautions and product-specific notes must be observed.**
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Important notes

7. Our manufacturing sites serving the automotive business apply the IATF 16949 standard.
The IATF certifications confirm our compliance with requirements regarding the quality management system in the automotive industry. Referring to customer requirements and customer specific requirements ("CSR") TDK always has and will continue to have the policy of respecting individual agreements. Even if IATF 16949 may appear to support the acceptance of unilateral requirements, we hereby like to emphasize that **only requirements mutually agreed upon can and will be implemented in our Quality Management System**. For clarification purposes we like to point out that obligations from IATF 16949 shall only become legally binding if individually agreed upon.

8. The trade names EPCOS, CarXield, CeraCharge, CeraDiode, CeraLink, CeraPad, CeraPlas, CSMP, CTVS, DeltaCap, DigiSiMic, FilterCap, FormFit, InsuGate, LeaXield, MediPlas, MiniBlue, MiniCell, MKD, MKK, ModCap, MotorCap, PCC, PhaseCap, PhaseCube, PhaseMod, PhiCap, PiezoBrush, PlasmaBrush, PowerHap, PQSine, PQvar, SIFERRIT, SIFI, SIKOREL, SilverCap, SIMDAD, SiMic, SIMID, SineFormer, SIOV, SurfIND, ThermoFuse, WindCap, YieldCap are **trademarks registered or pending** in Europe and in other countries. Further information will be found on the Internet at www.tdk-electronics.tdk.com/trademarks.

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